Characteristic Feature

- Superior in-field critical current and excellent mechanical properties applicable for magnet applications
- Original key manufacturing techniques of IBAD & PLD process enabling high superconducting performance



Typical Thickness 0.11-0.13 mm

Schematic of Typical specification



Typical Specifications

Products	Width	Thickness	Substrate	Stabilizer	Critical Current [A]	
	[mm]	[mm]	[µm]	[µm]	77K, S.F.	20K, 5T ^{*3}
FYSC-SCH04	4	0.13	75	20	≥ 165	368
FYSC-SCH12	12	0.13	75	20	≥ 550	1,104
FYSC-S12 *1	12	0.08	75	-	≥ 550	-
FESC-SCH02 *2	2	0.11	50	20	≥ 30	257
FESC-SCH03 *2	3	0.11	50	20	≥ 63	497
FESC-SCH04 *2	4	0.11	50	20	≥ 85	663
FESC-SCH12 *2	12	0.11	50	20	≥ 250	1,990
FESC-S12 *1,2	12	0.06	50	_	≥ 250	-

*1 Non-copper stabilizer specification is available in typically 12mm-wide for current lead or low thermal conducting applications.

*2 Artificial pinning specification is mainly for use in magnet applications at low temperature and high magnetic field.

*3 Ic@20K, 5T is a reference value and no guarantee of the actual performance.

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America

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Typical In-field Ic Performance

Non-artificial pinning: FYSC series



Artificial pinning type: FESC series



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Typical Field Angle Dependence

Non-artificial pinning: FYSC series



Artificial pinning type: FESC series



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Degradation Free 2G HTS : Type FPI

- Relaxation of delamination stress by fluorine coating enables to fabricate epoxy-impregnated coils without degradation drastically easily.
- Type FPI with Fluorine-coated polyimide insulation is optionally available for copper plating products of FYSC and FESC.



Proven Epoxy Impregnated Coil



Cross-section of Pancake Coil



Double Pancake Coil with Vacuum Pressure Impregnation



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Note for Handling at Heating



- It shall be generally recommendable to heat below 200 degrees C within few minutes. Heating over 200 degrees C could be also acceptable with full attentions to heating condition.
- These conditions shall not be necessarily applicable to HTS tapes with silver protection layer due to soldering erosion of silver layer.

Recommendable soldering Condition

- It shall be generally recommendable to use solders with low melting point and to heat below 200 degrees C within few minutes. In case it would be difficult to melt solder, heating over 200 deg C could be also acceptable with full attentions.
- Pb-free solder could be available with full attention to heating condition. Other solders could be also available depending on application designs or environmental regulation.
- Sn-Bi based or more preferably Sn-Bi-Ag based solder would be recommendable for HTS tapes with silver protection layer such as FYSC-S or FESC-S series. Especially solder including Ag is relatively easy to solder silver protection layer.

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